DESCRIPTION

The SPN3446 is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits, and low in-line power loss are needed in a very small outline surface mount package.

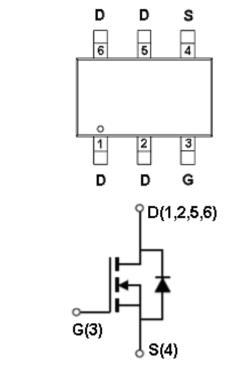
FEATURES

- 20V/6.0A, RDS(ON)= $33m\Omega(@VGS=4.5V)$
- 20V/5.0A, RDS(ON)= $38m\Omega$ @VGS=2.5V
- ◆ Super high density cell design for extremely low RDS (ON)
- Exceptional on-resistance and maximum DC current capability
- ◆ SOT-23-6L package design

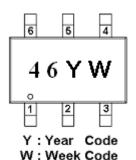
APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

PIN CONFIGURATION(SOT-23-6L)



PART MARKING



PIN DESCRIPTION						
Pin	Symbol	Description				
1	D	Drain				
2	D	Drain				
3	G	Gate				

S

Source

5 D Drain 6 D Drain

ORDERING INFORMATION

4

Part Number	Package	Part Marking
SPN3446S26RGB	SOT-23-6L	46

% Week Code : A ~ Z(1 ~ 26); a ~ z(27 ~ 52)

※ SPN3446S26RGB : Tape Reel ; Pb − Free ; Halogen − Free

ABSOULTE MAXIMUM RATINGS

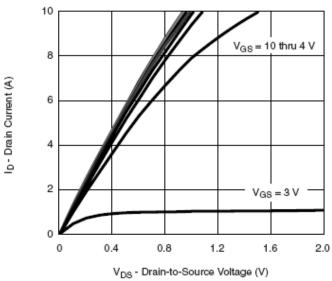
(TA=25°C Unless otherwise noted)

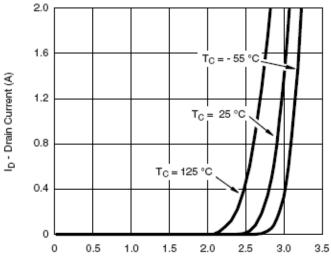
Parameter		Symbol	Typical	Unit	
Drain-Source Voltage		Vdss	20	V	
Gate –Source Voltage		VGSS	±12	V	
Continuous Dusin Cumant/Tr-150°C)	TA=25°C	In	6.8	Δ.	
Continuous Drain Current(T _J =150°C)	Ta=70°C	- Id	4.8	A	
Pulsed Drain Current		Ірм	30	A	
Continuous Source Current(Diode Conduction)		Is	1.6	A	
Decree Discipation	Ta=25°C	PD	2.8	W	
Power Dissipation	Ta=70°C		1.8	W	
Operating Junction Temperature		TJ	150	°C	
Storage Temperature Range		Tstg	-55/150	°C	
Thermal Resistance-Junction to Ambient		RθJA	105	°C/W	

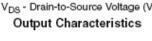
ELECTRICAL CHARACTERISTICS

(Ta=25°C Unless otherwise noted)

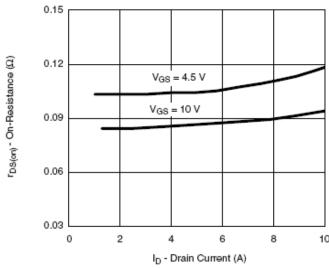
Parameter	Symbol	Conditions	Min.	Тур	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V(BR)DSS	Vgs=0V,Id=250uA	20			V
Gate Threshold Voltage	VGS(th)	S(th) VDS=VGS,ID=250uA			1.0]
Gate Leakage Current	Igss	VDS=0V,VGS=±12V			±100	nA
Zero Gate Voltage Drain Current		VDS=20V,VGS=0V			1	uA
	Idss	V _{DS} =20V,V _{GS} =0V T _J =55°C			5	
On-State Drain Current	ID(on)	$V_{DS} \leq 5V, V_{GS} = 4.5V$	6			A
Drain-Source On-Resistance	RDS(on)	Vgs =4.5V,Id=6.0A		0.028	0.033	Ω
	KD3(0II)	$V_{GS} = 2.5V, I_{D} = 5.0A$		0.032	0.038	3.2
Forward Transconductance	gfs	VDS=5V,ID=3.6A		10		S
Diode Forward Voltage	Vsd	Is=1.7A,VGS=0V		0.8	1.2	V
Dynamic						
Total Gate Charge	Qg			2		nC
Gate-Source Charge	Qgs	VDS=10V, VGS=4.5V ID=6.0A		2.5		
Gate-Drain Charge	Qgd	-ID-0.0A		2.1		
Input Capacitance	Ciss	V _{DS} =8V, V _{GS} =0V f=1MHz		575		pF
Output Capacitance	Coss			84		
Reverse Transfer Capacitance	Crss			22		
Turn-On Time	td(on)	VDD=10V ,RL=6Ω		10	14	
	tr			16	20	
Turn-Off Time	td(off)	$I_{D=1.0A,VGEN=4.5V}$ $R_{G}=6\Omega$		35	40	nS
	tf			3	10]

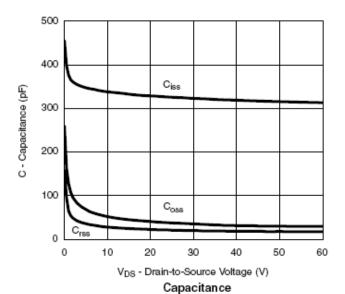




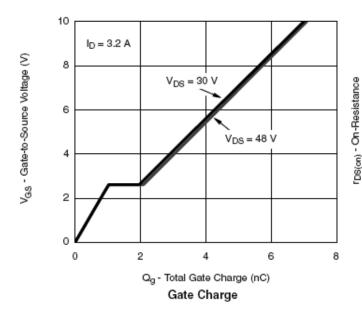


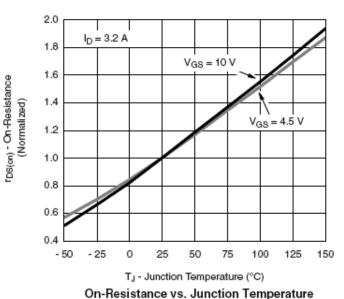


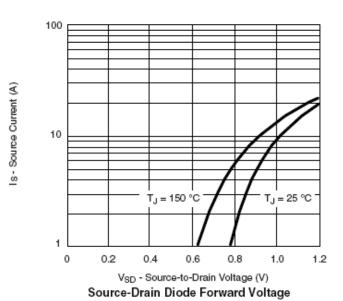


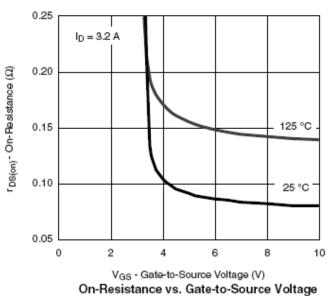


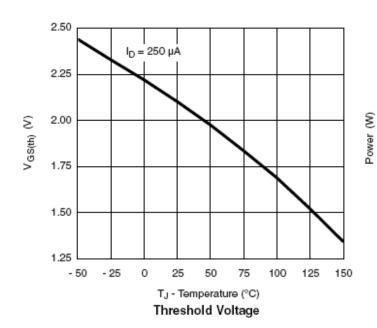
On-Resistance vs. Drain Current and Gate Voltage

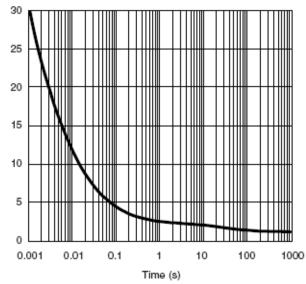




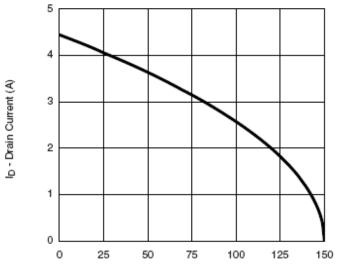


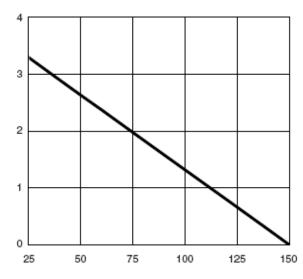






Single Pulse Power (Junction-to-Ambient)





T_C - Foot (Drain) Temperature (°C)

Current Derating*

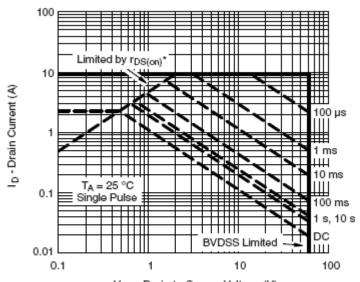
T_C - Foot (Drain) Temperature (°C)

Power Derating

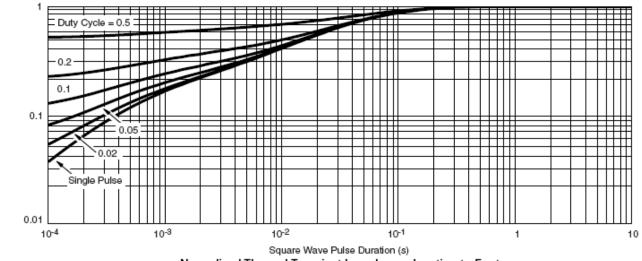
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Power Dissipation (W)

Nomalized Effective Transient Thermal Impedance



$$\begin{split} &V_{DS}\text{ - Drain-to-Source Voltage (V)}\\ ^*V_{GS}>&\min V_{GS}\text{ at which }r_{DS(on)}\text{ is specified}\\ \textbf{Safe Operating Area, Junction-to-Ambient} \end{split}$$



Normalized Thermal Transient Impedance, Junction-to-Foot

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